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Applicant		NXP Semiconductors						
FCC ID:		XXMFRDMKW24D512						
Section 15.212 Modular Transmitters								
Request for Modular Approval			for Limited Modular Approval					
		Requiremen	ts		EUT Conditions	Con	nply(Y/N)	
Single Modular Approval Requirements								
1	The radio	elements of	the	modular	Refer to external photos.	N		
	transmitter r	nust have their	own	shielding.	This module does not have			
	The physical crystal and tuning capacitors may be located external to the shielded radio elements.			shield cover.				
2	The modul				All inputs to the modules	Υ		
		dulation/data	•		are buffered through logic			
		provided) to e			or microprocessor inputs.			
	module wi			part 15	Refer to Schematics.			
	requirement		condit					
2	excessive data rates or over-modulation.				Internal 2.27	V		
3		ar transmitte			Internal 3.3V power	Υ		
	its own pov	wer supply re	guiat	ion.	regulator. Please refer to			
4	The medule			+ oomanlı.	schematic	V		
4		ar transmitter enna and trans			The modular transmitter has a PCB antenna, The	Υ		
		s of §§15.203,			Maximum antenna gain is			
	-	he antenna n			2.42dBi.			
		attached o			2.12001.			
			pler	(at all				
	'	between the r	•	•				
		ncluding the		le). The				
		l installation"		-				
	•	ot applicable t	-					
		o limited mod						
	under paragi	raph (b) of this	sectio	n.				
5	The modu	lar transmit	ter r	nust be	The modular transmitter	Υ		
	tested in a	stand-alone o	config	guration,	is connected to laptop			
	i.e., the m	odule must	not b	e inside	when testing.			
	another d	evice during	tes	ting for	Please refer to setup			
	compliance	e with	par	t 15	Photo.			
	requireme	nts. Unless th	e tra	nsmitter				
	module wi	II be battery	y pov	vered, it				
	must com	ply with t	he	AC line				

	conducted requirements found in §15.207. AC or DC power lines and data input/output lines connected to the module must not contain ferrites, unless they will be marketed with the module (see §15.27(a)). The length of these lines shall be the length typical of actual use or, if that length is unknown, at least 10 centimeters to insure that there is no coupling between the case of the module and supporting equipment. Any accessories, peripherals, or support equipment connected to the module during testing shall be unmodified and commercially available (see §15.31(i)).		
6	support equipment connected to the module during testing shall be unmodified and commercially available (see §15.31(i)). If using a permanently affixed label, the modular transmitter must be labeled with its own FCC identification number, and, if the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains	Refer to the label.	Υ
	Transmitter Module FCC ID: XXMFRDMKW24D512" or "Contains FCC ID: XXMFRDMKW24D512". Any similar wording that expresses the same meaning may be used. The Grantee may either provide such a label, an example of which must be included in the application for equipment authorization, or, must provide adequate instructions along with the module which explain this requirement. In the latter case, a copy of these instructions must be included in the application for		

included in the application for

equipment authorization.

7	The modular transmitter must comply with any specific rules or operating requirements that ordinarily apply to a complete transmitter and the manufacturer must provide adequate instructions along with the module to explain any such requirements. A copy of these instructions must be included in the application for equipment authorization.	Refer to manual	Y
8	The modular transmitter must comply with any applicable RF exposure requirements in its final configuration.	The modular transmitter meets with the MPE calculations of § 1.1310 and §2.1091 RF exposure. Please refer to the test report.	Υ

Sincerely Yours,

Signature: James Hornig Digitally signed by James Hornig DN: cn=James Hornig, o=Board Solutions Compliance Engineer, ou=NXP Semiconductors, email=jim.hornig@nxp.com, c=US Date: 2017.06.28 20:27:23 -05'00'

Printed name: James Hornig Title: Compliance Engineer